



Product Change Notification

CN-202303028F

Issue date: 04 Apr 2023

Effective date: 17 Jul 2023

Here's your personalized quality information concerning products our customers and partners purchased from Nexperia.

For more details please contact your respective Nexperia CSR/AM.



Change of die, lead frame and mold compound for 5 A Schottky diodes in SOD128

Change Category

- Wafer Assembly Process
- Wafer Assembly Process
- Material
- Wafer Assembly Location
- Product Marking
- Mechanical Specification
- Packing/Shipping/Labeling
- Test Location
- Test Process
- Test Equipment
- Design
- Errata
- Electrical spec./Test coverage

Details of this change

The following items are changed in the affected products:

- New clip type with optimized geometry
- No silver spot on lead frame surface anymore
- Change of mold compound
- Shrinkage of die size from 1900 μm^2 to 1780 μm^2
- New die design
- Datasheet parameter IFSM "non-repetitive peak forward current" is measured with half sine wave pulses instead of square wave pulses
- Only for PMEG4050ETP: Datasheet parameter Vf @ 5 A, 125°C adjustment

PCN-FORM-Nexperia_CN-202303028F.xlsm:

https://qcm.nexperia.com/Document/DOC-552959/PCN-FORM-Nexperia_CN-202303028F.xlsm

SQR_SOD128_5A_types_BL252.pdf:

https://qcm.nexperia.com/Document/DOC-552958/SQR_SOD128_5A_types_BL252.pdf

PCN-202303028F_Change_overview-DeQuMa.xlsx:

https://qcm.nexperia.com/Document/DOC-552412/PCN-202303028F_Change_overview-DeQuMa.xlsx

PCN-Delta-Qualification-Matrix-CN-202303028F.xlsm:

<https://qcm.nexperia.com/Document/DOC-552271/PCN-Delta-Qualification-Matrix-CN-202303028F.xlsm>

Why do we implement this change?

- Improvement of robustness and inline control during assembly process
- Adaption of lead frame surface to new die design
- Improvement of robustness against delamination of mold compound
- Increase of production capacity
- Alignment with Nexperia and world technology standards
- Correction of Vf parameter in datasheet

Identification of affected products

Top Side Marking

Changed products can be identified by date code after implementation

Product availability

Production

Planned first shipment: 17 Jul 2023

Existing inventory will be shipped until depleted

Sample information

Samples are available upon request

Impact

No impact to the product's functionality anticipated

Data sheet revision

A new datasheet will be issued

Feedback

Your acknowledgement of this change, conform JEDEC J-STD-046, is expected till 04 May 2023. Lack of acknowledgement of the PCN constitutes acceptance of the change.

Additional information

[View Change Notification Online](#)

Contact and support

For all Quality Notification content inquiries, please contact your local Nexperia Sales Support Team.

For specific questions on this notice or the products affected please contact our specialist directly: pcn@nexperia.com

In case of distribution, please contact you distribution partner.

About Nexperia B.V.

We at Nexperia are the efficiency semiconductor company. We deliver over 90 billion products a year and as such service thousands of global customers, both directly and through our extensive network of channel partners. We are at the heart of billions of electronic devices in the Automotive, Mobile, Industrial, Consumer, Computing, and Communication Infrastructure segments.

You have received this email because you are a designated contact or subscribed to Nexperia Quality Notifications. Nexperia shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

If you would like to adjust your mailing preferences, please click [here](#).

